

HD74LV1GT14A

Inverter with Schmitt-trigger Input / CMOS Logic Level Shifter

REJ03D0119-0600Z (Previous ADE-205-329D (Z)) Rev.6.00 Sep.24.2003

Description

The HD74LV1GT14A is high-speed CMOS schmitt-trigger inverter using silicon gate CMOS process. With CMOS low power dissipation, it provides high-speed equivalent to LS–TTL series. The internal circuit of three stages construction with buffer provides wide noise margin and stable output. The input protection circuitry on this device allows over voltage tolerance on the input, allowing the device to be used as a logic–level translator from 3.0 V CMOS Logic to 5.0 V CMOS Logic or from 1.8 V CMOS logic to 3.0 V CMOS Logic while operating at the high-voltage power supply. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- TTL compatible input level.
 - Supply voltage range: 3.0 to 5.5 V

Operating temperature range: -40 to +85°C

• Logic-level translate function

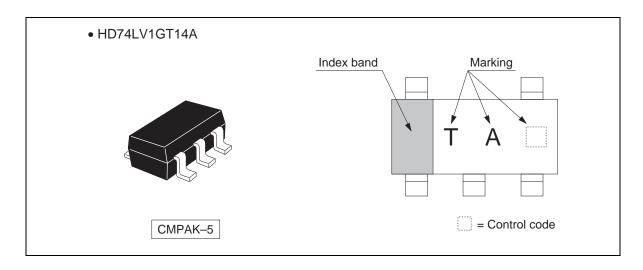
 $3.0 \text{ V CMOS logic} \rightarrow 5.0 \text{ V CMOS logic} (@V_{CC} = 5.0 \text{ V})$

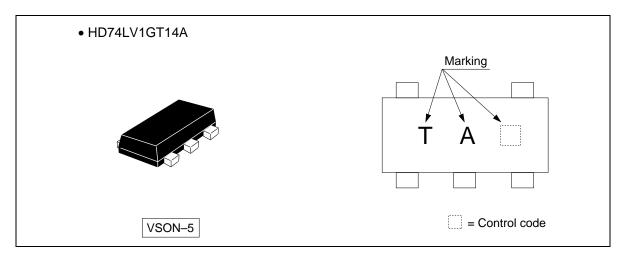
1.8 V or 2.5 V CMOS logic \rightarrow 3.3 V CMOS logic (@V_{CC} = 3.3 V)

- All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V) All outputs V_{O} (Max.) = 5.5 V (@V_{CC} = 0 V)
- Output current ± 6 mA (@V_{CC} = 3.0 V to 3.6 V), ± 12 mA (@V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV1GT14ACME	CMPAK-5 pin	CMPAK-5V	CM	E (3,000 pcs/reel)
		CMPAK-5V(O)	_	
HD74LV1GT14AVSE	VSON-5 pin	TNP-5DV	VS	_

Outline and Article Indication



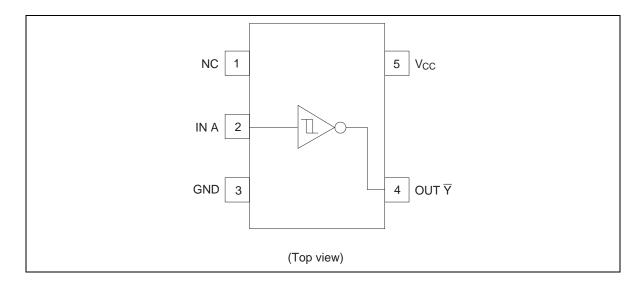


Function Table

Input A	Output Y
Н	L
L	Н

H : High level L : Low level

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V _{CC}	-0.5 to 7.0	V	
Input voltage range *1	Vı	-0.5 to 7.0	V	
Output voltage range *1, 2	Vo	-0.5 to V _{CC} + 0.5	V	Output : H or L
		-0.5 to 7.0		V _{CC} : OFF
Input clamp current	I _{IK}	-20	mA	V _I < 0
Output clamp current	I _{OK}	±50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	Io	±25	mA	$V_{O} = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P _T	200	mW	
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V _{CC}	3.0	5.5	V	
Input voltage range	VI	0	5.5	V	
Output voltage range	Vo	0	V _{CC}	V	
Output current	I _{OL}	_	6	mA	V _{CC} = 3.0 to 3.6 V
		_	12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
	I _{OH}	_	-6		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-12		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt / Δν	0	100	ns / V	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	20		$V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

HD74LV1GT14A

Electrical Characteristic

• $Ta = -40 \text{ to } 85^{\circ}\text{C}$

Item	Symbol	V _{CC} (V) *	Min	Тур	Max	Unit	Test condition
Input voltage	V _T ⁺	3.0	_	_	1.5	V	
		3.6	_	_	1.6	_	
		4.5	_	_	1.9	_	
		5.5	_	_	2.1	_	
	V _T	3.0	0.3	_	_	_	
		3.6	0.4	_	_	_	
		4.5	0.5	_	_	_	
		5.5	0.6	_	_	_	
	ΔV_T	3.0	0.3	_	1.2	_	
		3.6	0.3	_	1.3	_	
		4.5	0.4	_	1.4	_	
		5.5	0.4	_	1.5	_	
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1	_	_	V	I _{OH} = -50 μA
		3.0	2.48	_	_		$I_{OH} = -6 \text{ mA}$
		4.5	3.8	_	_		I _{OH} = -12 mA
	V _{OL}	Min to Max	_	_	0.1		I _{OL} = 50 μA
		3.0	_	_	0.44		I _{OL} = 6 mA
		4.5	_	_	0.55		I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	V _{IN} = 5.5 V or GND
Quiescent supply current	Icc	5.5	_	_	10	μΑ	$V_{IN} = V_{CC}$ or GND, $I_O = 0$
	ΔI_{CC}	5.5	_	_	1.5	mA	One input $V_{IN} = 3.4 \text{ V}$, other input V_{CC} or GND
Output leakage current	I _{OFF}	0	_	_	5	μΑ	V_{IN} or $V_O = 0$ to 5.5 V
Input capacitance	C _{IN}	5.0	_	3.0	_	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $\bullet \quad V_{CC} = 3.3 \pm 0.3 \ V$

Item	Symbol	Ta = 2	25°C		Ta = -40 to 85°C		Unit		FROM	ТО
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)
Propagation	t _{PLH}	_	7.5	12.5	1.0	14.5	ns	$C_L = 15 \text{ pF}$	A or B	Y
delay time	t _{PHL}	_	10.0	15.0	1.0	17.0	=	C _L = 50 pF	_	

 $\bullet \quad V_{CC} = 5.0 \pm 0.5 \ V$

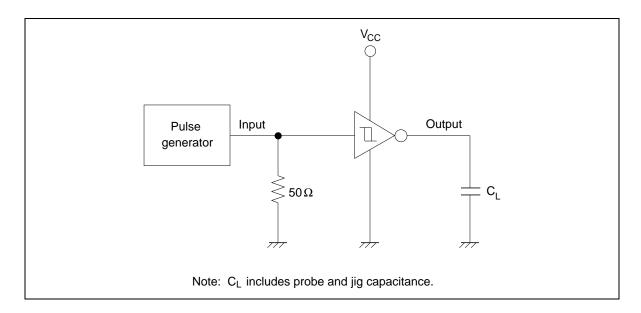
Item	Symbol	Ta = 2	25°C		$Ta = -40 \text{ to } 85^{\circ}\text{C}$		Ta = -40 to 85°C		Unit		FROM	ТО
		Min	Тур	Max	Min	Max	_	Conditions	(Input)	(Output)		
Propagation	t _{PLH}	_	5.0	7.6	1.0	9.0	ns	C _L = 15 pF	Α	Y		
delay time	t _{PHL}	_	6.5	9.6	1.0	11.0	_	C _L = 50 pF	_			

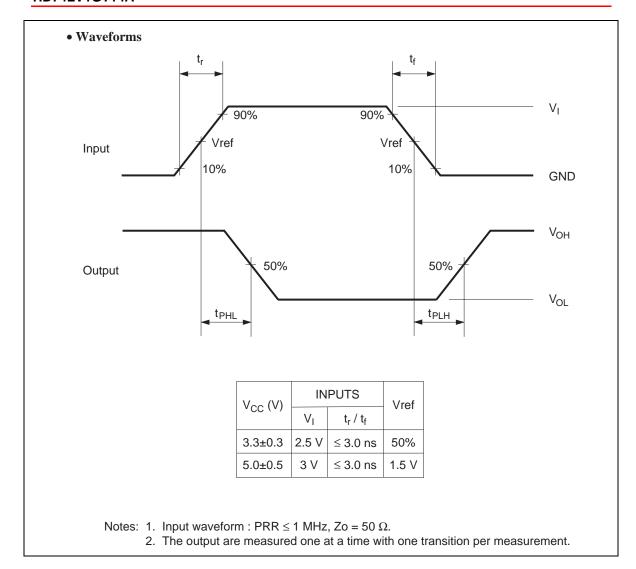
Operating Characteristics

• $C_L = 50 \text{ pF}$

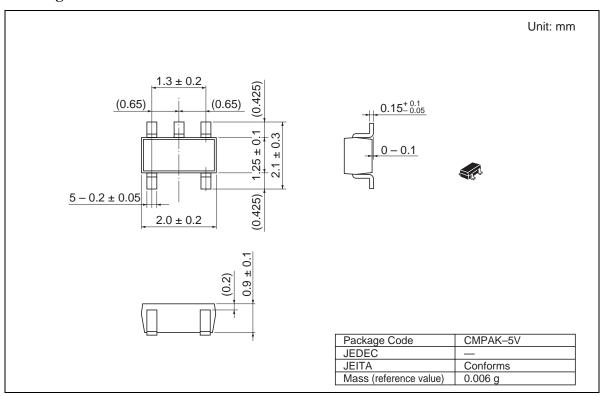
Item	Symbol	V _{CC} (V)	Ta = 25°C			Ta = 25°C			Unit	Test Conditions	
			Min	Тур	Max	_					
Power dissipation capacitance	C_{PD}	5.0	_	10.0	_	pF	f = 10 MHz				

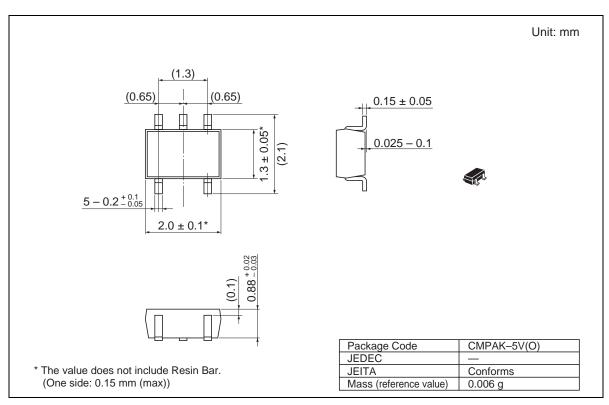
Test Circuit

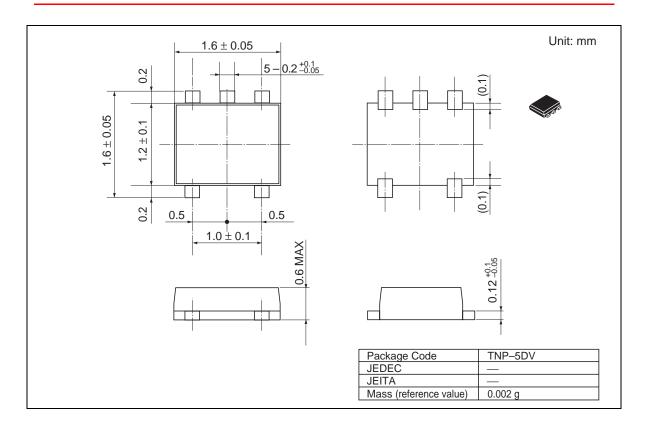




Package Dimensions







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